Supporting Information:

Experimental Section

Catalyst Preparation: In a typical synthesis, a mixture of 6 g CTAB(Cetyltrimethyl Ammonium Bromide, Sonopharm), 15 ml of 1-butanol (Sonopharm), and 80 ml of cyclohexane (Sonopharm) was vigorously stirred and a solution containing 0.05 M $Cu(NO_{3})_2$ (Sonopharm) and 0.05 M $Ni(NO_3)_2$ (4 ml, Sonopharm) was added to prepare microemulsion A. The aqueous phase of Microemulsion B was prepared using the solution of 0.5 ml hydrazine (98%, Sonopharm) and 1.5 ml NaOH (0.5M, Sonopharm). Microemulsion A was mixed with B at 70 °C. After 40 min, the solution was change into room temperature, TEOS (700 ul, Sonopharm) and NH₄OH (85%, 1 ml, Sonopharm) were added dropwise into the system under stirring, respectively. Hydrolysis and condensation of the silica precursors was allowed for 3 days at 25°C. After 3 days, CuNi@SiO₂ was precipitated and washed by ethanol five times to remove CTAB. The CuNi@SiO₂ was dried at 120°C and annealed at 500 °C in H₂ for 5 h. The synthesis of CuNi control nanoparticle was identical to the above procedure without adding SiO₂ precursor.

Catalyst test: Catalysis were performed in a fixed bed flow reactor (Fantai) at atmospheric pressure. In each experiment, 90 mg of the catalyst was installed in the fixed bed and reduced with H_2/N_2 (50 ml/min) at 500 °C for 2 h. After the H_2 pretreatment, a gas mixture of 20% CH₄ and 20% CO₂ in Ar at a total flow of 20 ml/min was introduced to test the activity of the catalyst in DRM reation. The reaction temperature was ranged from 500 °C to 900 °C. The reactor effluent was analyzed using GC (Tianmei). The mass balance of the effluents was within 10% of the feed for most catalysts at reaction temperatures.

Table1. The size of the alloy nanoparticles estimated by the XRD peak broadening using Scherrer's equation. The result of ICP show some difference to the precursor concentration.

catalyst	d (nm)	precursor concentration	ICP(Ni:Cu)
		(Ni:Cu)	
Cu ₁ Ni ₁	14.3	50:50	55:45
Cu ₁ Ni _{2.5}	16.7	71:29	76:24
Cu ₁ Ni ₄	18.9	80:20	87:13



Figure S1. (a) XRD patterns of $\text{CuNi}_x @SiO_2$ with x = 0, 1, 2.5, and 4. (b) Shifts of the diffraction peaks of the alloy nanoparticles relative to the pure Ni nanoparticles. All of the samples were annealed in H₂ (500 °C, 3h).



Figure S2a,b. XPS of Cu 2p and Ni 2p of the CuNi_{2.5}@SiO₂ catalyst. The binding energy of Cu 2p 932.8 ev can be ascribed to Cu^0 binding energy in CuNi nanoalloy.^[11] The bingding energy of Ni 2p 855.6 ev can be assigned to NiSiO₃, which can be ascribed to the oxidation of surface Ni atoms and the bonding with the silica shell. Similar phenomenon has been reported by Chen.^[11]



Figure S3. The morphology of $Cu_1Ni_{2.5}@SiO_2\left(a\right)$ and $Cu_1Ni_4@SiO_2\left(b\right)$ nanostructure.



Figure S4. The morphology of CuNi nanoparticles synthesized without silica shells (a) and CuNi@SiO₂ nanostructure with more than one metal cores encapsulated in one silica shell (b).



Figure S5. The stability of Cu-Ni@SiO₂ tested at 700 $^{\circ}$ C for 16 h.